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Kind regards,

Team Nexperia



PMBT3946VPN

40 V, 200 mA NPN/PNP switching transistor

Rev. 01 — 31 August 2009

Product data sheet

1. Product profile

1.1 General description

NPN/PNP double switching transistor in a SOT666 ultra small and flat lead Surface-Mounted Device (SMD) plastic package.

Table 1. Product overview

Type number	Package N		NPN/NPN	PNP/PNP
	NXP	JEITA	complement	complement
PMBT3946VPN	SOT666	-	PMBT3904VS	PMBT3906VS

1.2 Features

- Double general-purpose switching transistor
- Board-space reduction
- Ultra small and flat lead SMD plastic package

1.3 Applications

■ General-purpose switching and amplification

1.4 Quick reference data

Table 2. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit			
Per trans	Per transistor; for the PNP transistor with negative polarity								
V_{CEO}	collector-emitter voltage	open base	-	-	40	V			
I _C	collector current		-	-	200	mA			
TR1 (NPN	TR1 (NPN)								
h _{FE}	DC current gain	$V_{CE} = 1 V;$ $I_{C} = 10 \text{ mA}$	100	180	300				
TR2 (PNF	P)								
h _{FE}	DC current gain	$V_{CE} = -1 \text{ V};$ $I_{C} = -10 \text{ mA}$	100	180	300				



2. Pinning information

Table 3. Pinning

Table 3.	riiiiiig		
Pin	Description	Simplified outline	Graphic symbol
1	emitter TR1		
2	base TR1	6 5 4	6 5 4
3	collector TR2		TR2
4	emitter TR2		(TR1)
5	base TR2	1 2 3	
6	collector TR1	1 2 3	1 2 3
			sym019

3. Ordering information

Table 4. Ordering information

Type number	Package				
	Name	Description	Version		
PMBT3946VPN	-	plastic surface-mounted package; 6 leads	SOT666		

4. Marking

Table 5. Marking codes

Type number	Marking code
PMBT3946VPN	ZE

5. Limiting values

Table 6. Limiting values

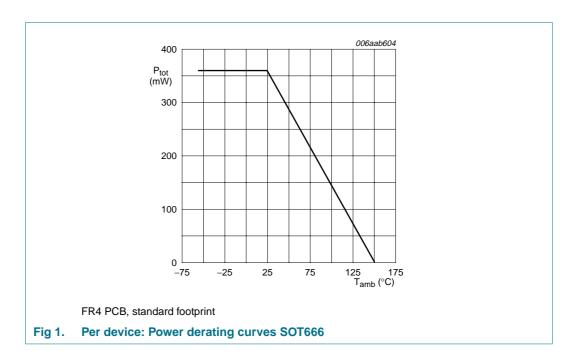
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
TR1 (NPI	N)				
V_{CBO}	collector-base voltage	open emitter	-	60	V
TR2 (PNF	P)				
V_{CBO}	collector-base voltage	open emitter	-	-40	V
Per trans	istor; for the PNP transistor w	ith negative polarity			
V_{CEO}	collector-emitter voltage	open base	-	40	V
V_{EBO}	emitter-base voltage	open collector	-	6	V
I _C	collector current		-	200	mA
I _{CM}	peak collector current	single pulse; $t_p \le 1 \text{ ms}$	-	200	mA
I _{BM}	peak base current	single pulse; $t_p \le 1 \text{ ms}$	-	100	mA
P _{tot}	total power dissipation	$T_{amb} \le 25 ^{\circ}C$	[1][2]	240	mW

Table 6. Limiting values ...continued
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
Per devic	е				
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C	[1][2]	360	mW
Tj	junction temperature		-	150	°C
T _{amb}	ambient temperature		-55	+150	°C
T_{stg}	storage temperature		-65	+150	°C

- [1] Reflow soldering is the only recommended soldering method.
- [2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.



6. Thermal characteristics

Table 7. Thermal characteristics

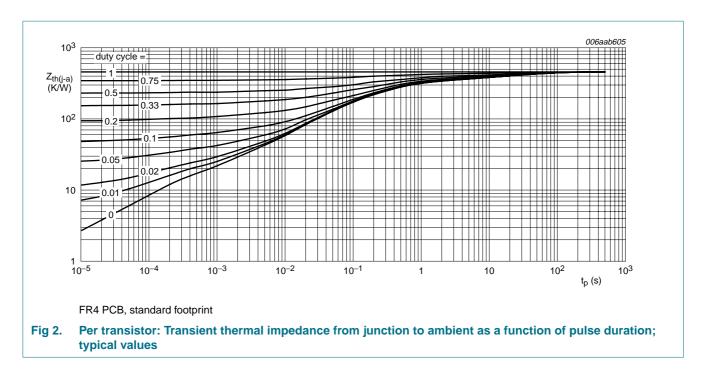
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per transi	istor					
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1][2]	-	521	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		-	-	100	K/W
Per devic	е					
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	[1][2] -	-	347	K/W

- [1] Reflow soldering is the only recommended soldering method.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

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40 V, 200 mA NPN/PNP switching transistor



7. Characteristics

Table 8. Characteristics

 T_{amb} = 25 °C unless otherwise specified.

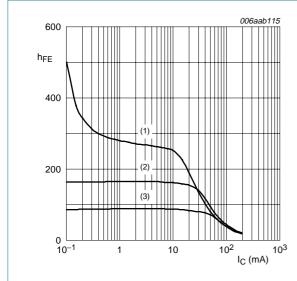
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
TR1 (NPN	۷)					
I _{CBO}	collector-base cut-off current	$V_{CB} = 30 \text{ V}; I_E = 0 \text{ A}$	-	-	50	nA
I _{EBO}	emitter-base cut-off current	$V_{EB} = 6 \text{ V}; I_C = 0 \text{ A}$	-	-	50	nA
h _{FE}	DC current gain	V _{CE} = 1 V				
		$I_C = 0.1 \text{ mA}$	60	180	-	
		$I_C = 1 \text{ mA}$	80	180	-	
		$I_C = 10 \text{ mA}$	100	180	300	
		$I_C = 50 \text{ mA}$	60	105	-	
		$I_C = 100 \text{ mA}$	30	50	-	
V_{CEsat}	collector-emitter	$I_C = 10 \text{ mA}; I_B = 1 \text{ mA}$	-	75	200	mV
	saturation voltage	$I_C = 50 \text{ mA}; I_B = 5 \text{ mA}$	-	120	300	mV
V_{BEsat}	base-emitter	$I_C = 10 \text{ mA}; I_B = 1 \text{ mA}$	650	750	850	mV
	saturation voltage	$I_C = 50 \text{ mA}; I_B = 5 \text{ mA}$	-	850	950	mV

Table 8. Characteristics ... continued $T_{amb} = 25 \,^{\circ}C$ unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t _d	delay time	$V_{CC} = 3 \text{ V}; I_{C} = 10 \text{ mA};$	-	-	35	ns
t _r	rise time	$I_{Bon} = 1 \text{ mA};$ $I_{Boff} = -1 \text{ mA}$	-	-	35	ns
t _{on}	turn-on time		-	-	70	ns
t _s	storage time		-	-	200	ns
t _f	fall time		-	-	50	ns
t _{off}	turn-off time		-	-	250	ns
C _c	collector capacitance	$V_{CB} = 5 \text{ V}; I_E = i_e = 0 \text{ A};$ f = 1 MHz	-	-	4	pF
C _e	emitter capacitance	$V_{EB} = 500 \text{ mV};$ $I_C = i_c = 0 \text{ A}; f = 1 \text{ MHz}$	-	-	8	pF
f _T	transition frequency	$V_{CE} = 20 \text{ V}; I_{C} = 10 \text{ mA};$ f = 100 MHz	300	-	-	MHz
NF	noise figure	$V_{CE} = 5 \text{ V}; I_{C} = 100 \mu\text{A};$ $R_{S} = 1 k\Omega;$ $f = 10 \text{ Hz} \text{ to } 15.7 \text{ kHz}$	-	-	5	dB
TR2 (PNF	P)					
I _{CBO}	collector-base cut-off current	$V_{CB} = -30 \text{ V}; I_E = 0 \text{ A}$	-	-	-50	nA
I _{EBO}	emitter-base cut-off current	$V_{EB} = -6 \text{ V}; I_C = 0 \text{ A}$	-	-	-50	nA
h _{FE}	DC current gain	$V_{CE} = -1 V$				
		$I_C = -0.1 \text{ mA}$	60	180	-	
		$I_C = -1 \text{ mA}$	80	180	-	
		$I_C = -10 \text{ mA}$	100	180	300	
		$I_C = -50 \text{ mA}$	60	130	-	
		$I_C = -100 \text{ mA}$	30	50	-	
V _{CEsat}	collector-emitter	$I_C = -10 \text{ mA}; I_B = -1 \text{ mA}$	-	-100	-250	mV
	saturation voltage	$I_C = -50 \text{ mA}; I_B = -5 \text{ mA}$	-	-165	-400	mV
V _{BEsat}	base-emitter	$I_C = -10 \text{ mA}; I_B = -1 \text{ mA}$	-	-750	-850	mV
	saturation voltage	$I_C = -50 \text{ mA}; I_B = -5 \text{ mA}$	-	-850	-950	mV
t _d	delay time	$V_{CC} = -3 \text{ V};$	-	-	35	ns
t _r	rise time	$I_{C} = -10 \text{ mA};$ $I_{Bon} = -1 \text{ mA};$	-	-	35	ns
t _{on}	turn-on time	$I_{Bon} = -1 \text{ mA},$ $I_{Boff} = 1 \text{ mA}$	-	-	70	ns
t _s	storage time		-	-	225	ns
t _f	fall time		-	-	75	ns
t _{off}	turn-off time		-	-	300	ns
C _c	collector capacitance	$V_{CB} = -5 \text{ V}; I_E = i_e = 0 \text{ A};$ f = 1 MHz	-	-	4.5	pF

Table 8. Characteristics ...continued $T_{amb} = 25 \,^{\circ}C$ unless otherwise specified.

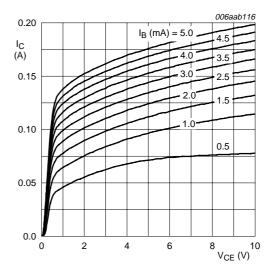
amb	•					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
C _e	emitter capacitance	$V_{EB} = -500 \text{ mV};$ $I_C = i_c = 0 \text{ A}; f = 1 \text{ MHz}$	-	-	10	pF
f _T	transition frequency	$V_{CE} = -20 \text{ V};$ $I_{C} = -10 \text{ mA};$ $f = 100 \text{ MHz}$	250	-	-	MHz
NF	noise figure	$\begin{split} &V_{CE} = -5 \text{ V;} \\ &I_{C} = -100 \mu\text{A; R}_{S} = 1 k\Omega; \\ &f = 10 \text{ Hz to 15.7 kHz} \end{split}$	-	-	4	dB





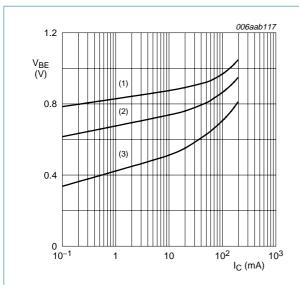
- (1) $T_{amb} = 150 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = -55 \, ^{\circ}C$

Fig 3. TR1 (NPN): DC current gain as a function of collector current; typical values



 $T_{amb} = 25 \, ^{\circ}C$

Fig 4. TR1 (NPN): Collector current as a function of collector-emitter voltage; typical values



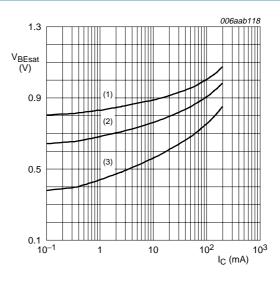
$$V_{CE} = 1 V$$

(1)
$$T_{amb} = -55 \,^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3) $T_{amb} = 150 \, ^{\circ}C$

Fig 5. TR1 (NPN): Base-emitter voltage as a function of collector current; typical values



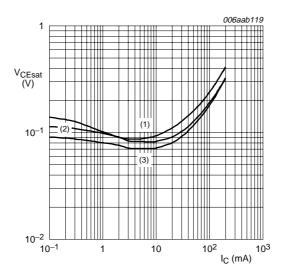
$$I_{\rm C}/I_{\rm B} = 10$$

(1)
$$T_{amb} = -55 \, ^{\circ}C$$

(2)
$$T_{amb} = 25 \, ^{\circ}C$$

(3)
$$T_{amb} = 150 \, ^{\circ}C$$

Fig 6. TR1 (NPN): Base-emitter saturation voltage as a function of collector current; typical values



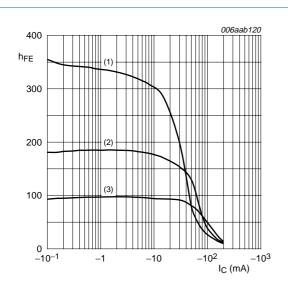
$$I_{\rm C}/I_{\rm B}=10$$

(1) $T_{amb} = 150 \, ^{\circ}C$

(2) $T_{amb} = 25 \, ^{\circ}C$

(3) $T_{amb} = -55 \,^{\circ}C$

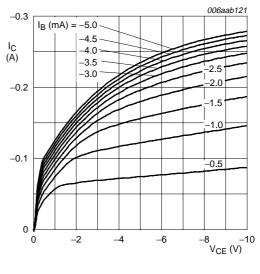
Fig 7. TR1 (NPN): Collector-emitter saturation voltage as a function of collector current; typical values





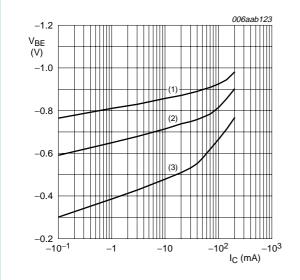
- (1) $T_{amb} = 150 \, ^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = -55 \,^{\circ}C$

Fig 8. TR2 (PNP): DC current gain as a function of collector current; typical values



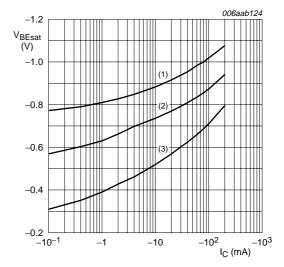
 $T_{amb} = 25 \, ^{\circ}C$

Fig 9. TR2 (PNP): Collector current as a function of collector-emitter voltage; typical values



- $V_{CE} = -1 V$
- (1) $T_{amb} = -55 \,^{\circ}C$
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = 150 \, ^{\circ}C$

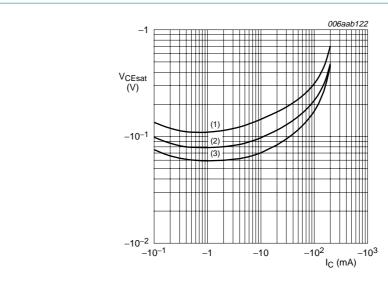
Fig 10. TR2 (PNP): Base-emitter voltage as a function of collector current; typical values



 $I_{\rm C}/I_{\rm B} = 10$

- (1) $T_{amb} = -55$ °C
- (2) $T_{amb} = 25 \, ^{\circ}C$
- (3) $T_{amb} = 150 \, ^{\circ}C$

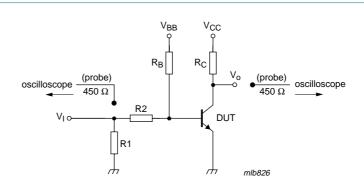
Fig 11. TR2 (PNP): Base-emitter saturation voltage as a function of collector current; typical values



- $I_{\rm C}/I_{\rm B} = 10$
- (1) $T_{amb} = 150 \, ^{\circ}C$
- (2) $T_{amb} = 25 \,^{\circ}C$
- (3) $T_{amb} = -55 \, ^{\circ}C$

Fig 12. TR2 (PNP): Collector-emitter saturation voltage as a function of collector current; typical values

8. Test information

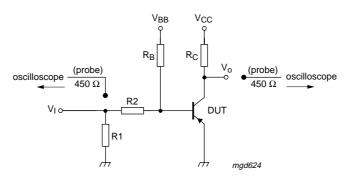


$$\begin{split} V_I = 5 \ V; \ t = 600 \ \mu s; \ t_p = 10 \ \mu s; \ t_r = t_f \leq 3 \ ns \\ R1 = 56 \ \Omega; \ R2 = 2.5 \ k\Omega; \ R_B = 3.9 \ k\Omega; \ R_C = 270 \ \Omega \end{split}$$

 $V_{BB} = -1.9 \text{ V}; V_{CC} = 3 \text{ V}$

Oscilloscope: input impedance Z_i = 50 Ω

Fig 13. TR1 (NPN): Test circuit for switching times



 $V_1 = 5 \text{ V}; t = 600 \text{ } \mu\text{s}; t_p = 10 \text{ } \mu\text{s}; t_r = t_f \leq 3 \text{ ns}$

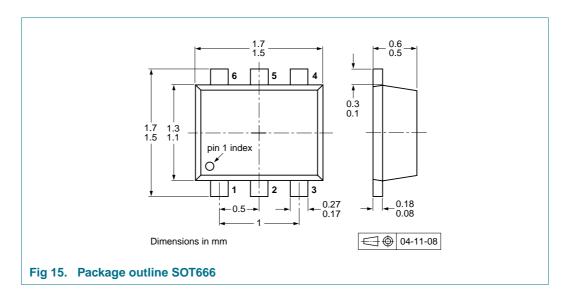
R1 = 56 Ω ; R2 = 2.5 k Ω ; R_B = 3.9 k Ω ; R_C = 270 Ω

 $V_{BB} = 1.9 \text{ V}; V_{CC} = -3 \text{ V}$

Oscilloscope: input impedance Z_i = 50 Ω

Fig 14. TR2 (PNP): Test circuit for switching times

9. Package outline



10. Packing information

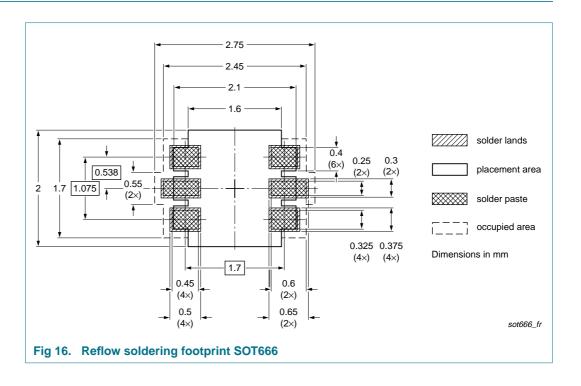
Table 9. Packing methods

The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description	Packing quantity	
			4000	8000
PMBT3946VPN SOT666	SOT666	2 mm pitch, 8 mm tape and reel	-	-315
		4 mm pitch, 8 mm tape and reel	-115	-

[1] For further information and the availability of packing methods, see Section 14.

11. Soldering





12. Revision history

Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PMBT3946VPN_1	20090831	Product data sheet	-	-

13. Legal information

13.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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14. Contact information

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PMBT3946VPN

40 V, 200 mA NPN/PNP switching transistor

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